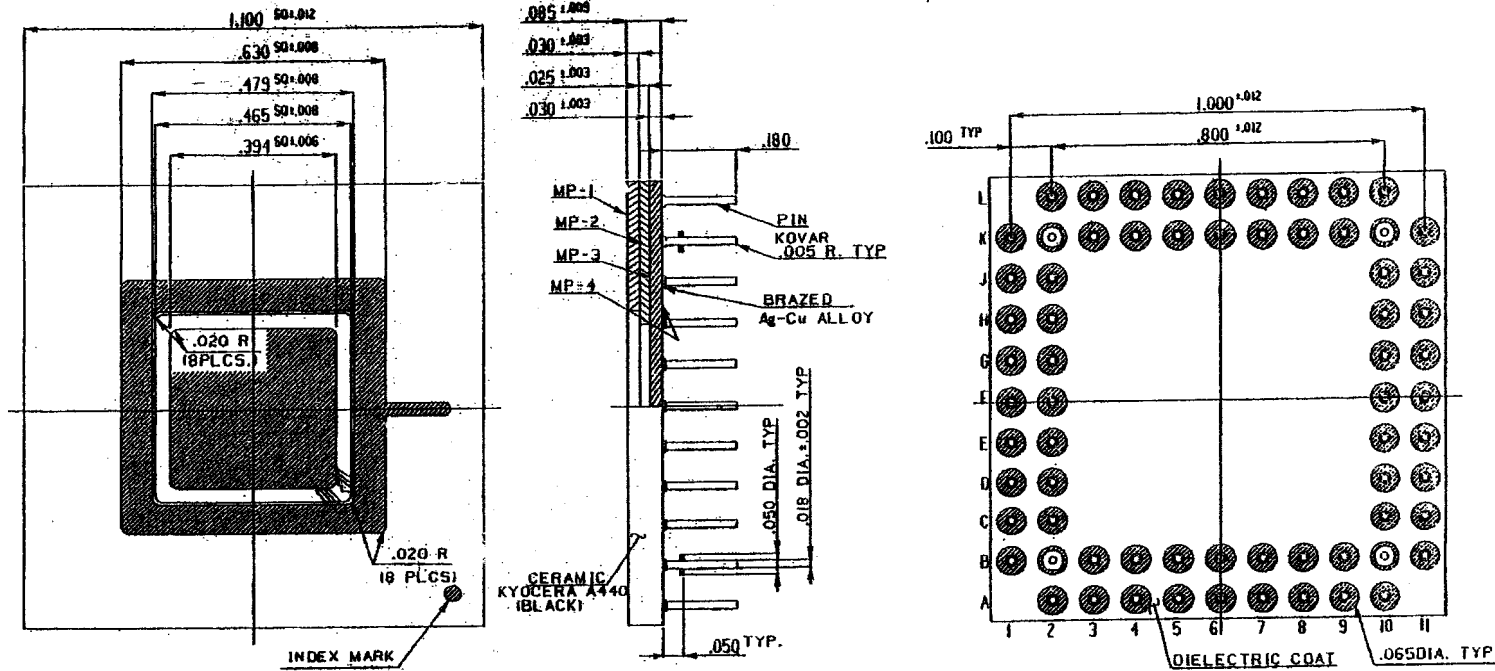


SSM P/N CPG06861

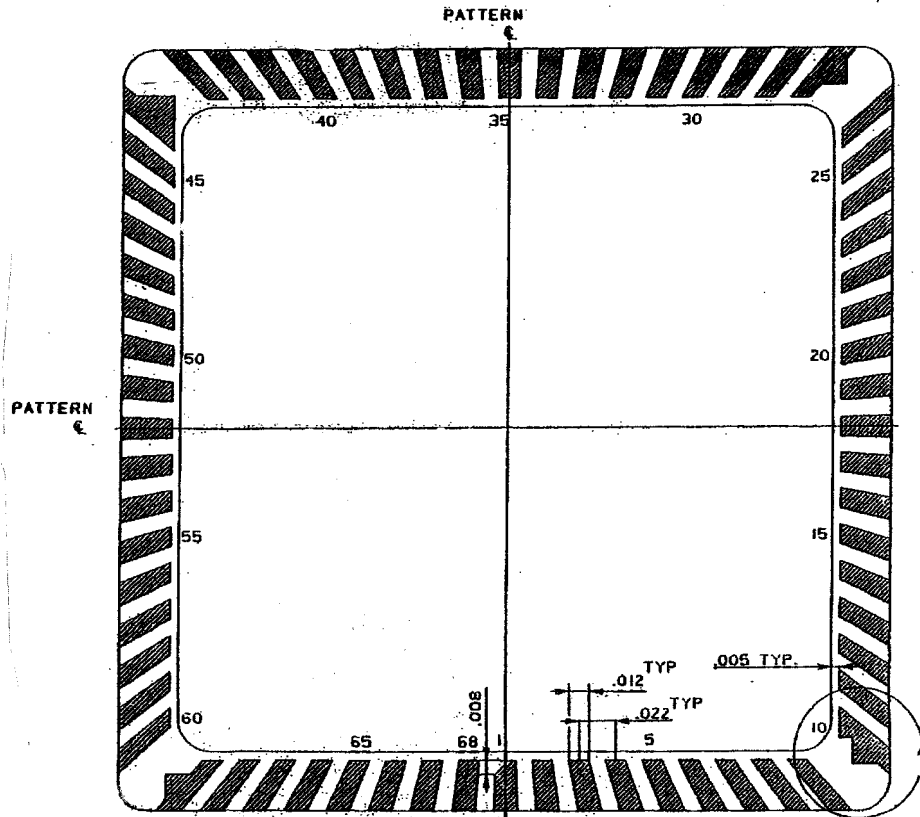


- NOTES**
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE METALLIZED.
 4. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.
 5. LEAD RESISTANCE : 500mΩMAX.

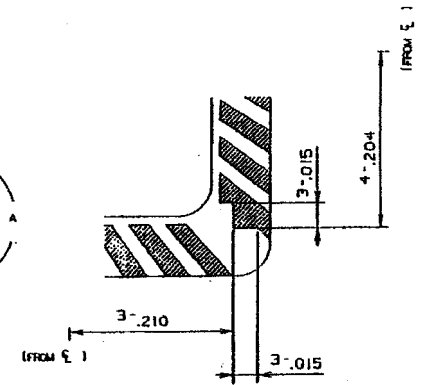
| | | | | | | | | | | | |
|---------------------------|--|------------------------------------|--|-------------|--|-----------|--|----------|--|--------|--|
| NAME | | TOLERANCE | | DRAWN | | CHECKED | | APPROVED | | DATE | |
| 68 PIN GRID ARRAY PACKAGE | | ±.005 | | H.S. | | A.F./T.A. | | K.M. | | AUG 65 | |
| SCALE 5/1 | | MATERIAL AS INDICATED | | DRAWING NO. | | KD-P92727 | | | | | |
| KYOCERA | | KYOCERA CORPORATION KYOTO JAPAN | | | | | | | | | |



SSM P/N CPG06861



BONDING PATTERN



DETAIL A


| | | | | | | |
|--|----------|---|---------------|----------------------|------------------|---------------|
| NAME 68 PIN GRID ARRAY PACKAGE | | TOLERANCE UNLESS OTHERWISE SPECIFIED | DRAWN H.S. | CHECKED A.F./T.A. | APPROVED K.M. | DATE N/G/S |
| SCALE 20/1 | MATERIAL | FINISH AND PROTECTION | | | | |
|  KYOCERA CORPORATION KYOTO JAPAN | | DRAWING NO. KD-P92727 | | | | |



SSM P/N CPG06861

WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

| W/B NO. | PIN NO. | W/B NO. | PIN NO. | W/B NO. | PIN NO. | W/B NO. | PIN NO. |
|---------|---------|---------|---------|---------|---------|---------|---------|
| 1 | A6 | 21 | G2 | 41 | L9 | 61 | A10 |
| 2 | B6 | 22 | H1 | 42 | K9 | 62 | B10 |
| 3 | A5 | 23 | H2 | 43 | L10 | 63 | A9 |
| 4 | B5 | 24 | J1 | 44 | K11 | 64 | B9 |
| 5 | A4 | 25 | J2 | 45 | K10 | 65 | A8 |
| 6 | B4 | 26 | K1 | 46 | J11 | 66 | B8 |
| 7 | A3 | 27 | L2 | 47 | J10 | 67 | A7 |
| 8 | B3 | 28 | K2 | 48 | H11 | 68 | B7 |
| 9 | A2 | 29 | L3 | 49 | H10 | | |
| 10 | B1 | 30 | K3 | 50 | G11 | | |
| 11 | B2 | 31 | L4 | 51 | G10 | S/R | N/C |
| 12 | C1 | 32 | K4 | 52 | F11 | D/A | N/C |
| 13 | C2 | 33 | L5 | 53 | F10 | | |
| 14 | D1 | 34 | K5 | 54 | E11 | | |
| 15 | D2 | 35 | L6 | 55 | E10 | | |
| 16 | E1 | 36 | K6 | 56 | D11 | | |
| 17 | E2 | 37 | L7 | 57 | D10 | | |
| 18 | F1 | 38 | K7 | 58 | C11 | | |
| 19 | F2 | 39 | L8 | 59 | C10 | | |
| 20 | G1 | 40 | K8 | 60 | B11 | | |

| | | | | | | |
|---|----------|---|--------------------------|----------------------|------------------|---------------|
| NAME 68 PIN GRID ARRAY PACKAGE | | TOLERANCE UNLESS OTHERWISE SPECIFIED | DRAWN H.S. | CHECKED A.F./T.F. | APPROVED K.M. | DATE AUG.5 |
| SCALE / | MATERIAL | THIRD ANGLE PROJECTION | DRAWING NO. KD-P92727 | | | |
|  KYOCERA CORPORATION KYOTO JAPAN | | | | | | 3 |

